

FACED PANEL

CEPPO LS92

SUPPORT: Chipboard, MDF
FORMAT: 5600 x 2070 mm
THICKNESS: from 8 to 38 mm
TEXTURE ORIENTATION: Vertical
BACK TEXTURE: Ceppo
NOMINAL OVERTHICKNESS: +0.1 mm

LAMINATE

CEPPO LS92

TYPE: HPL
FORMAT: 2760 x 2040 mm
THICKNESS: 0.9 mm

EDGE

CEPPO LS92

TYPE: ABS
HEIGHT: from 15 to 330 mm
THICKNESS: from 0.5 to 2.0 mm

Pictures and descriptions should be considerate for illustration purposes only. Cleaf reserves the right to make, at any time and without notice, any necessary modifications for commercial or manufacturing purposes. The finished product might have different shades from the picture presented.